



Integrated Device Technology, Inc.

FAST CMOS 16-BIT BIDIRECTIONAL TRANSCEIVERS

IDT54/74FCT16245T/AT/CT/ET
 IDT54/74FCT162245T/AT/CT/ET
 IDT54/74FCT166245T/AT/CT
 IDT54/74FCT162H245T/AT/CT/ET

FEATURES:

- Common features:

- 0.5 MICRON CMOS Technology
- High-speed, low-power CMOS replacement for ABT functions
- Typical t_{sk(o)} (Output Skew) < 250ps
- Low input and output leakage $\leq 1\mu A$ (max.)
- ESD > 2000V per MIL-STD-883, Method 3015;
 > 200V using machine model (C = 200pF, R = 0)
- 25 mil pitch SSOP and Cerpak Packages and
 19.6 mil pitch TSSOP Package
- Extended commercial range of -40°C to +85°C

- Features for FCT16245T/AT/CT/ET:

- High drive outputs (-32mA I_{OH}, 64mA I_{OL})
- Power off disable outputs permit "live insertion"
- Typical VOLP (Output Ground Bounce) < 1.0V at V_{CC} = 5V, TA = 25°C

- Features for FCT162245T/AT/CT/ET:

- Balanced Output Drivers: $\pm 24mA$ (commercial),
 $\pm 16mA$ (military)
- Reduced system switching noise
- Typical VOLP (Output Ground Bounce) < 0.6V at V_{CC} = 5V, TA = 25°C

DESCRIPTION:

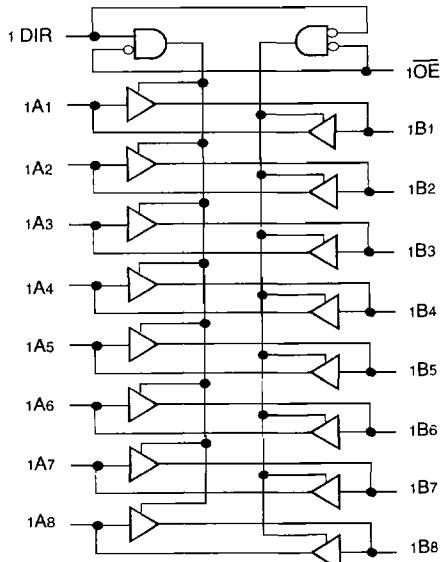
The 16-bit transceivers are built using advanced dual metal CMOS technology. These high-speed, low-power transceivers are ideal for synchronous communication between two busses (A and B). The Direction and Output Enable controls operate these devices as either two independent 8-bit transceivers or one 16-bit transceiver. The direction control pin (xDIR) controls the direction of data flow. The output enable pin (xOE) overrides the direction control and disables both ports. All inputs are designed with hysteresis for improved noise margin.

The FCT16245T are ideally suited for driving high-capacitance loads and low-impedance backplanes. The output buffers are designed with power off disable capability to allow "live insertion" of boards when used as backplane drivers.

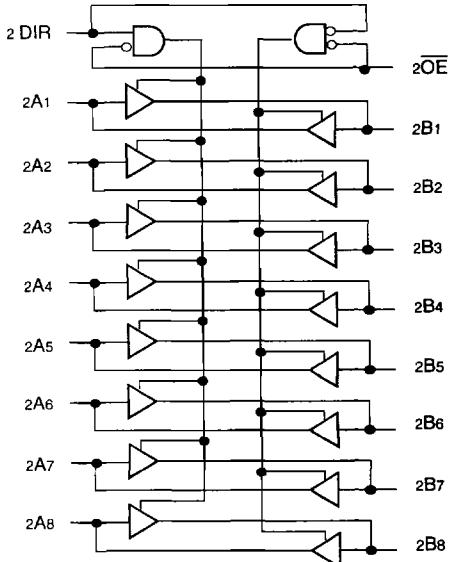
The FCT162245T have balanced output drive with current limiting resistors. This offers low ground bounce, minimal undershoot, and controlled output fall times—reducing the need for external series terminating resistors. The FCT162245T are plug-in replacements for the FCT16245T and ABT16245 for on-board interface applications.

The FCT166245T are suited for very low noise, point-to-point driving where there is a single receiver, or a tight lumped

FUNCTIONAL BLOCK DIAGRAM



2545 drw 01



2545 drw 02

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MILITARY AND COMMERCIAL TEMPERATURE RANGES

JUNE 1996

FEATURES: (Cont'd.)**• Features for FCT166245T/AT/CT:**

- Light Drive A Port: $\pm 8\text{mA}$ (commercial),
 $\pm 6\text{mA}$ (military)
- High Drive B Port: $+64\text{mA}, -32\text{mA}$ (commercial),
 $+48\text{mA}, -24\text{mA}$ (military)
- Minimal system switching noise
- Typical VOLP (Output Ground Bounce) $< 0.25\text{V}$ at
 $V_{CC} = 5\text{V}, T_A = 25^\circ\text{C}$ (A Port Switching)

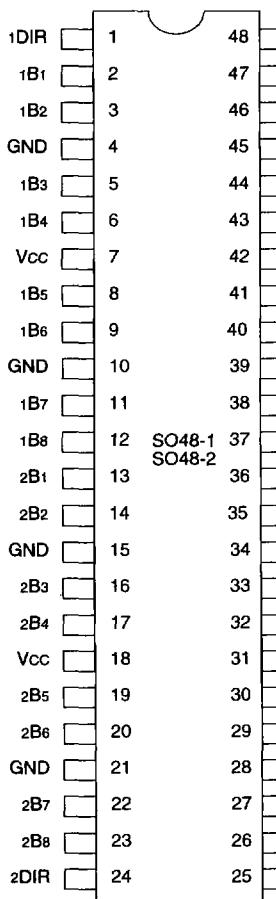
• Features for FCT162H245T/AT/CT/ET:

- Bus Hold retains last active bus state during 3-state
- Eliminates the need for external pull up resistors

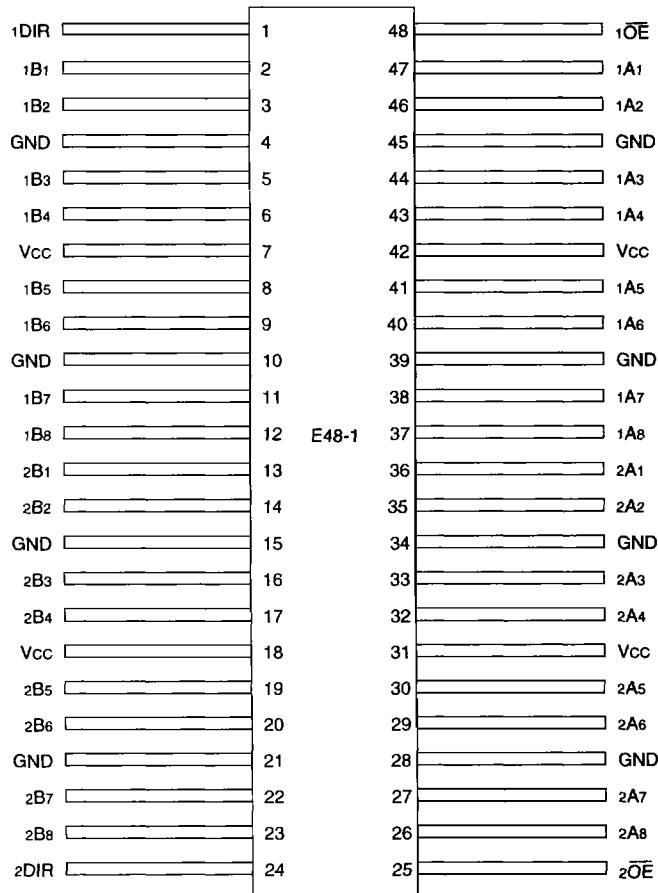
DESCRIPTION: (Cont'd.)

load ($< 100\text{pF}$). The buffers are designed to limit the output current to levels which will avoid noise and ringing on the signal lines without using external series terminating resistors. These parts have a $\pm 8\text{mA}$ driver on the "A" Port and a $+64/-32\text{mA}$ driver on the "B" Port, making them ideal for interfacing noisy system busses to noise sensitive interfaces.

The FCT162H245T have "Bus Hold" which retains the input's last state whenever the input goes to high impedance. This prevents "floating" inputs and eliminates the need for pull-up/down resistors.

PIN CONFIGURATIONSSSOP
TSSOP
TOP VIEW

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CERPACK
TOP VIEW

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PIN DESCRIPTION

Pin Names	Description
xOE	Output Enable Input (Active LOW)
xDIR	Direction Control Input
xAx	Side A Inputs or 3-State Outputs ^(1,2)
xBx	Side B Inputs or 3-State Outputs ^(1,3)

NOTES:

1. On FCT162H245T these pins have "Bus Hold". All other pins are standard inputs, outputs or I/Os.
 2. On FCT166245T this is the ±8mA Port.
 3. On FCT166245T this is the +64/-32mA Port.

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FUNCTION TABLE⁽¹⁾

Inputs		Outputs
xOE	xDIR	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	High Z State

NOTE:

1. H = HIGH Voltage Level
 L = LOW Voltage Level
 X = Don't Care
 Z = High Impedance

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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Commercial	Military	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc +0.5	-0.5 to Vcc +0.5	V
TA	Operating Temperature	-40 to +85	-55 to +125	°C
TBIAS	Temperature Under Bias	-55 to +125	-65 to +135	°C
TSTG	Storage Temperature	-55 to +125	-65 to +150	°C
PT	Power Dissipation	1.0	1.0	W
IOUT	DC Output Current	-60 to +120	-60 to +120	mA

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
 2. All device terminals except FCT162XXXT and FCT166XXXT (A-Port) Output and I/O terminals.
 3. Output and I/O terminals for FCT162XXXT and FCT166XXXT (A-Port).

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CAPACITANCE (TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	3.5	6.0	pF
Cl/O	I/O Capacitance	VOUT = 0V	3.5	8.0	pF

NOTE:

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1. This parameter is measured at characterization but not tested.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE (STANDARD PARTS)

Following Conditions Apply Unless Otherwise Specified:

Commercial: $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$; Military: $T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
V_{IH}	Input HIGH Level	Guaranteed Logic HIGH Level		2.0	—	—	V
V_{IL}	Input LOW Level	Guaranteed Logic LOW Level		—	—	0.8	V
I_{IH}	Input HIGH Current (Input pins) ⁽⁵⁾	$V_{CC} = \text{Max.}$	$V_I = V_{CC}$	—	—	± 1	μA
	Input HIGH Current (I/O pins) ⁽⁵⁾			—	—	± 1	
I_{IL}	Input LOW Current (Input pins) ⁽⁵⁾	$V_{CC} = \text{Max.}$	$V_I = \text{GND}$	—	—	± 1	μA
	Input LOW Current (I/O pins) ⁽⁵⁾			—	—	± 1	
I_{OZH}	High Impedance Output Current (3-State Output pins) ⁽⁵⁾	$V_{CC} = \text{Max.}$	$V_O = 2.7\text{V}$	—	—	± 1	μA
I_{OZL}			$V_O = 0.5\text{V}$	—	—	± 1	
V_{IK}	Clamp Diode Voltage	$V_{CC} = \text{Min.}, I_{IN} = -18\text{mA}$		—	-0.7	-1.2	V
I_{OS}	Short Circuit Current	$V_{CC} = \text{Max.}, V_O = \text{GND}$ ⁽³⁾		-80	-140	-225	mA
V_H	Input Hysteresis	—		—	100	—	mV
I_{CCL} I_{CCH} I_{CCZ}	Quiescent Power Supply Current	$V_{CC} = \text{Max.}, V_{IN} = \text{GND or } V_{CC}$		—	5	500	μA

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OUTPUT DRIVE CHARACTERISTICS FOR FCT16245T AND FCT166245T (B-PORT)

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
I_O	Output Drive Current	$V_{CC} = \text{Max.}, V_O = 2.5\text{V}$ ⁽³⁾		-50	—	-180	mA
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -3\text{mA}$	2.5	3.5	—	V
			$I_{OH} = -12\text{mA MIL.}$ $I_{OH} = -15\text{mA COM'L.}$	2.4	3.5	—	V
			$I_{OH} = -24\text{mA MIL.}$ $I_{OH} = -32\text{mA COM'L.}$ ⁽⁴⁾	2.0	3.0	—	V
V_{OL}	Output LOW Voltage		$I_{OL} = 48\text{mA MIL.}$ $I_{OL} = 64\text{mA COM'L.}$	—	0.2	0.55	V
I_{OFF}	Input/Output Power Off Leakage ⁽⁵⁾	$V_{CC} = 0\text{V}, V_{IN}$ or $V_O \leq 4.5\text{V}$		—	—	± 1	μA

2545 Ink 06

OUTPUT DRIVE CHARACTERISTICS FOR FCT162245T

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit	
I_{ODL}	Output LOW Current	$V_{CC} = 5\text{V}, V_{IN} = V_{IH}$ or V_{IL} , $V_{OUT} = 1.5\text{V}$ ⁽³⁾		60	115	200	mA	
I_{ODH}	Output HIGH Current	$V_{CC} = 5\text{V}, V_{IN} = V_{IH}$ or V_{IL} , $V_{OUT} = 1.5\text{V}$ ⁽³⁾		-60	-115	-200	mA	
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}		$I_{OH} = -16\text{mA MIL.}$ $I_{OH} = -24\text{mA COM'L.}$	2.4	3.3	—	V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}		$I_{OL} = 16\text{mA MIL.}$ $I_{OL} = 24\text{mA COM'L.}$	—	0.3	0.55	V

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OUTPUT DRIVE CHARACTERISTICS FOR FCT166245T (A-PORT ONLY)

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit	
I_{ODL}	Output LOW Current	$V_{CC} = 5\text{V}, V_{IN} = V_{IH}$ or V_{IL} , $V_{OUT} = 1.5\text{V}$ ⁽³⁾		16	48	96	mA	
I_{ODH}	Output HIGH Current	$V_{CC} = 5\text{V}, V_{IN} = V_{IH}$ or V_{IL} , $V_{OUT} = 1.5\text{V}$ ⁽³⁾		-16	-48	-96	mA	
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}		$I_{OH} = -6\text{mA MIL.}$ $I_{OH} = -8\text{mA COM'L.}$	2.4	3.3	—	V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}		$I_{OL} = 6\text{mA MIL.}$ $I_{OL} = 8\text{mA COM'L.}$	—	0.3	0.55	V

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NOTES:

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at $V_{CC} = 5.0\text{V}$, $+25^\circ\text{C}$ ambient.
- Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- Duration of the condition can not exceed one second.
- The test limit for this parameter is $\pm 5\mu\text{A}$ at $T_A = -55^\circ\text{C}$.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE (BUS HOLD)

Following Conditions Apply Unless Otherwise Specified:

Commercial: $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$; Military: $T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter		Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
V_{IH}	Input HIGH Level		Guaranteed Logic HIGH Level		2.0	—	—	V
V_{IL}	Input LOW Level		Guaranteed Logic LOW Level		—	—	0.8	V
I_{IH}	Input HIGH Current ⁽⁴⁾	Standard Input ⁽⁵⁾	V _{CC} = Max.	V _I = V _{CC}	—	—	± 1	μA
		Standard I/O ⁽⁵⁾			—	—	± 1	
		Bus Hold Input			—	—	± 100	
		Bus Hold I/O			—	—	± 100	
I_{IL}	Input LOW Current ⁽⁴⁾	Standard Input ⁽⁵⁾	V _I = GND	V _I = GND	—	—	± 1	μA
		Standard I/O ⁽⁵⁾			—	—	± 1	
		Bus Hold Input			—	—	± 100	
		Bus Hold I/O			—	—	± 100	
I_{BHH} I_{BHL}	Bus Hold Sustain Current ⁽⁴⁾	Bus Hold Input	V _{CC} = Min.	V _I = 2.0V	—50	—	—	μA
					+50	—	—	
I_{OZH} I_{OZL}	High Impedance Output Current (3-State Output pins) ^(5,6)		V _{CC} = Max.	V _O = 2.7V	—	—	± 1	μA
					—	—	± 1	
V_{IK}	Clamp Diode Voltage		V _{CC} = Min., $I_{IN} = -18\text{mA}$	—	—	-0.7	-1.2	V
					—	—	—	
I_{OS}	Short Circuit Current		V _{CC} = Max., $V_O = \text{GND}^{(3)}$	—80	-140	-225	mA	
V_H	Input Hysteresis		—	—	100	—	mV	
I_{CCL} I_{CCH} I_{CCZ}	Quiescent Power Supply Current		V _{CC} = Max., $V_{IN} = \text{GND or } V_{CC}$	—	5	500	μA	

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NOTES:

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at $V_{CC} = 5.0\text{V}$, $+25^\circ\text{C}$ ambient.
- Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- Pins with Bus Hold are identified in the pin description.
- The test limit for this parameter is $\pm 5\mu\text{A}$ at $T_A = -55^\circ\text{C}$.
- Does not include Bus Hold I/O pins.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
ΔI_{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V _{CC} = Max. V _{IN} = 3.4V ⁽³⁾		—	0.5	1.5	mA
I _{CCD}	Dynamic Power Supply Current ⁽⁴⁾	V _{CC} = Max. Outputs Open $x\bar{O}E \approx xDIR = GND$ One Input Toggling 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND	—	60	100	$\mu A/$ MHz
I _C	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max. Outputs Open $f_i = 10MHz$ 50% Duty Cycle $x\bar{O}E \approx xDIR = GND$ One Bit Toggling	V _{IN} = V _{CC} V _{IN} = GND	—	0.6	1.5	mA
		V _{IN} = 3.4V V _{IN} = GND	—	0.9	2.3		
		V _{IN} = V _{CC} V _{IN} = GND	—	2.4	4.5 ⁽⁵⁾		
		V _{IN} = 3.4V V _{IN} = GND	—	6.4	16.5 ⁽⁵⁾		

NOTES:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at V_{CC} = 5.0V, +25°C ambient.

3. Per TTL driven input (V_{IN} = 3.4V). All other inputs at V_{CC} or GND.

4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.

5. Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.

6. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$

$$I_C = I_{CC} + \Delta I_{CC} D_{HNT} + I_{CCD} (f_{CP} N_{CP}/2 + f_i N_i)$$

I_{CC} = Quiescent Current (I_{CCL}, I_{CH} and I_{CCZ})

ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)

D_H = Duty Cycle for TTL Inputs High

N_T = Number of TTL Inputs at D_H

I_{CCD} = Dynamic Current Caused by an Input Transition Pair (H_{LH} or L_{HL})

f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)

N_{CP} = Number of Clock Inputs at f_{CP}

f_i = Input Frequency

N_i = Number of Inputs at f_i

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Symbol	Parameter	Condition ⁽¹⁾	FCT16245T/162245T ⁽⁵⁾				FCT16245AT/162245AT ⁽⁵⁾				Unit	
			Com'l.		Mil.		Com'l.		Mil.			
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.		
t _{PLH}	Propagation Delay A to B, B to A	CL = 50pF RL = 500Ω	1.5	7.0	1.5	7.5	1.5	4.6	1.5	4.9	ns	
t _{PHL}			1.5	9.5	1.5	10.0	1.5	6.2	1.5	6.5	ns	
t _{PZH}	Output Enable Time xOE to A or B		1.5	7.5	1.5	10.0	1.5	5.0	1.5	6.0	ns	
t _{PZL}	xOE to A or B		1.5	9.5	1.5	10.0	1.5	6.2	1.5	6.5	ns	
t _{PHZ}	Output Enable Time xDIR to A or B ⁽⁴⁾		1.5	7.5	1.5	10.0	1.5	5.0	1.5	6.0	ns	
t _{PZL}	xDIR to A or B ⁽⁴⁾		—	—	—	—	—	—	—	—	ns	
tsk(o)	Output Skew ⁽³⁾		—	0.5	—	0.5	—	0.5	—	0.5	ns	

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Symbol	Parameter	Condition ⁽¹⁾	FCT16245CT/162245CT ⁽⁵⁾				FCT16245ET/162245ET ⁽⁵⁾				Unit	
			Com'l.		Mil.		Com'l.		Mil.			
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.		
t _{PLH}	Propagation Delay A to B, B to A	CL = 50pF RL = 500Ω	1.5	4.1	1.5	4.5	1.5	3.2	—	—	ns	
t _{PHL}			1.5	5.8	1.5	6.2	1.5	4.4	—	—	ns	
t _{PZH}	Output Enable Time xOE to A or B		1.5	4.8	1.5	5.2	1.5	4.0	—	—	ns	
t _{PZL}	xOE to A or B		1.5	5.8	1.5	6.2	1.5	4.8	—	—	ns	
t _{PHZ}	Output Enable Time xDIR to A or B ⁽⁴⁾		1.5	4.8	1.5	5.2	1.5	4.0	—	—	ns	
t _{PZL}	xDIR to A or B ⁽⁴⁾		—	—	—	—	—	—	—	—	ns	
tsk(o)	Output Skew ⁽³⁾		—	0.5	—	0.5	—	0.5	—	—	ns	

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NOTES:

- See test circuit and waveforms.
- Minimum limits are guaranteed but not tested on Propagation Delays.
- Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- This parameter is guaranteed but not tested.
- Including parts with Bus Hold.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

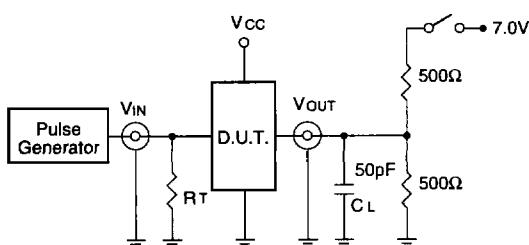
Symbol	Parameter	Condition ⁽¹⁾	FCT166245T				FCT166245AT				FCT166245CT				Unit	
			Com'l.		Mil.		Com'l.		Mil.		Com'l.		Mil.			
			Min. ⁽²⁾	Max.												
t _{PLH}	Propagation Delay A to B	CL = 50pF RL = 500Ω	1.5	4.6	1.5	4.9	1.5	4.1	1.5	4.5	—	—	—	—	ns	
t _{PHL}	Propagation Delay B to A		1.5	7.0	1.5	7.5	1.5	4.6	1.5	4.9	—	—	—	—	ns	
t _{PZH}	Output Enable Time x _{OE} to B		1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	—	—	—	—	ns	
t _{PZL}	Output Enable Time x _{OE} to A		1.5	9.5	1.5	10.0	1.5	6.2	1.5	6.5	—	—	—	—	ns	
t _{PHZ}	Output Disable Time x _{OE} to B		1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	—	—	—	—	ns	
t _{PZL}	Output Disable Time x _{OE} to A		1.5	7.5	1.5	10.0	1.5	5.0	1.5	6.0	—	—	—	—	ns	
t _{PZH}	Output Enable Time xDIR to B ⁽⁴⁾		1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	—	—	—	—	ns	
t _{PZL}	Output Enable Time xDIR to A ⁽⁴⁾		1.5	9.5	1.5	10.0	1.5	6.2	1.5	6.5	—	—	—	—	ns	
t _{PHZ}	Output Disable Time xDIR to B ⁽⁴⁾		1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	—	—	—	—	ns	
t _{PZL}	Output Disable Time xDIR to A ⁽⁴⁾		1.5	7.5	1.5	10.0	1.5	5.0	1.5	6.0	—	—	—	—	ns	
tsk(o)	Output Skew ⁽³⁾	—	—	0.5	—	0.5	—	0.5	—	0.5	—	—	—	—	ns	

NOTES:

1. See test circuit and waveforms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
4. This parameter is guaranteed but not tested.

TEST CIRCUITS AND WAVEFORMS

TEST CIRCUITS FOR ALL OUTPUTS



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SWITCH POSITION

Test	Switch
Open Drain	Closed
Disable Low	
Enable Low	
All Other Tests	Open

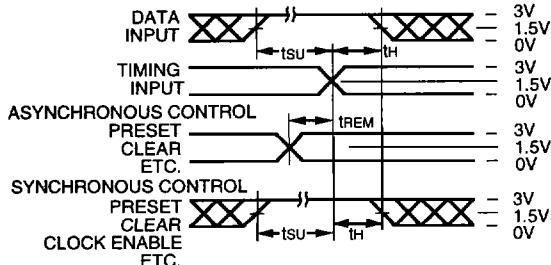
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DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

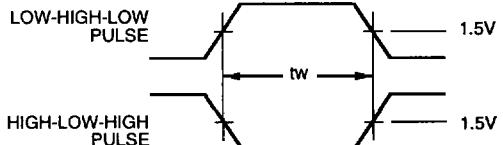
R_T = Termination resistance: should be equal to Z_{out} of the Pulse Generator.

SET-UP, HOLD AND RELEASE TIMES



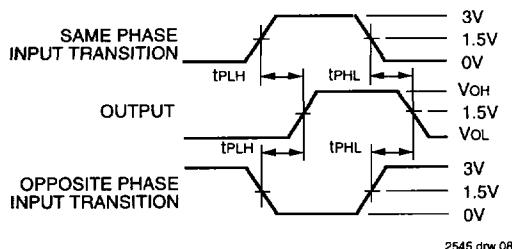
2545 drw 06

PULSE WIDTH



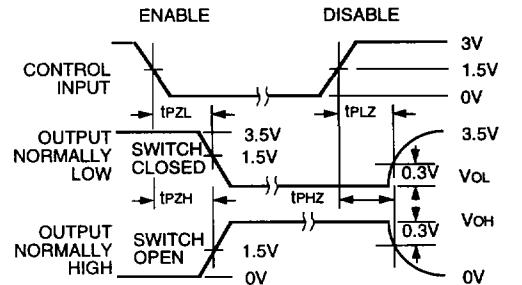
2545 drw 07

PROPAGATION DELAY



2545 drw 08

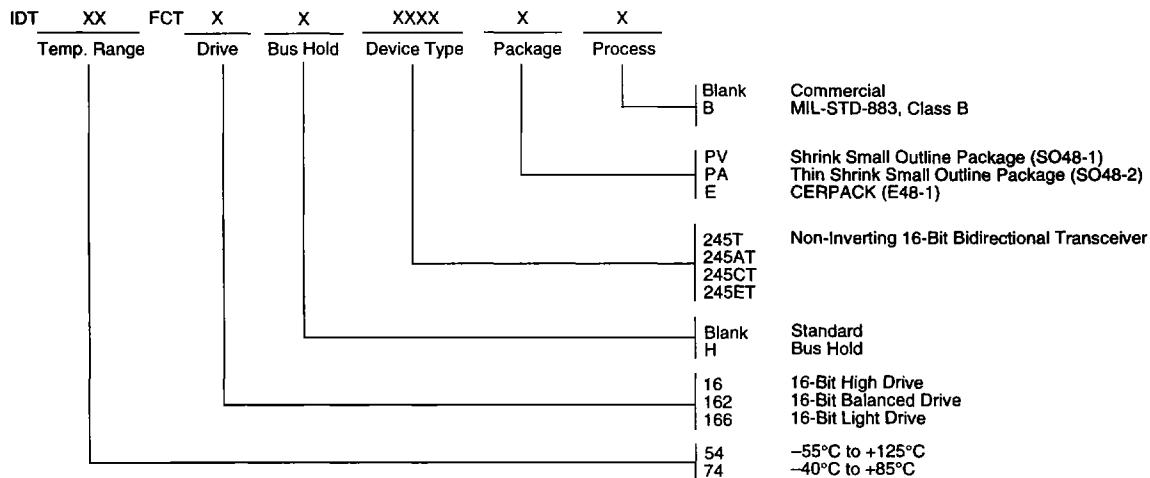
ENABLE AND DISABLE TIMES



2545 drw 09

NOTES:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH
2. Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $t_f \leq 2.5\text{ns}$; $t_r \leq 2.5\text{ns}$

ORDERING INFORMATION

2545 drw 10